

STPS41H100C-Y

Automotive low drop power Schottky rectifier

Features

- Negligible switching losses
- Low leakage current
- Good trade off between leakage current and foward voltage drop
- Low thermal resistance
- Avalanche capability specified
- AEC-Q101 qualified

Description

Dual center tab Schottky rectifier suited for switch mode power supply and high frequency DC to DC converters.

Packaged in D²PAK, this device is intended for use in high frequency inverters for automotive application.

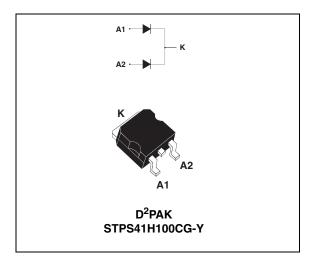


Table 1.Device summary

Symbol	Value
I _{F(AV)}	2 x 20 A
V _{RRM}	100 V
T _j (max)	175 °C
V _F (max)	0.67 V

1 Characteristics

Symbol	Paramete	Value	Unit			
V _{RRM}	Repetitive peak reverse voltage			100	V	
I _{F(RMS)}	Forward rms current			30	А	
1	$T_c = 50 \text{ °C}$ Per diode		Per diode	20	^	
I _{F(AV)}	Average forward current	$\delta = 0.5$	Per device	40	A	
I _{FSM}	Surge non repetitive forward current	t _p = 10 ms sir	nusoidal	220	А	
I _{RRM}	Repetitive peak reverse current	t _p = 2 μs squa	are F = 1 kHz	1	А	
P _{ARM}	Repetitive peak avalanche power $t_p = 1 \ \mu s \ T_j = 25 \ ^{\circ}C$			18100	W	
T _{stg}	Storage temperature range	-65 to + 175	°C			
Тj	Maximum operating junction temperature range ⁽¹⁾			-40 to + 175	°C	
dV/dt	Critical rate of rise of reverse voltage			10000	V/µs	
dPtot	1					

 Table 2.
 Absolute ratings (limiting values, per diode)

1. $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

Symbol	Parameter		Value	Unit
D	Junction to case	Per diode	1.5	
R _{th(j-c)}	Sunction to case	Total	0.8	°C/W
R _{th(c)}	Coupling		0.1	

When the diodes 1 and 2 are used simultaneously:

 Δ Tj(diode 1) = P(diode1) x R_{th(j-c)}(Per diode) + P(diode 2) x R_{th(c)}

Table 4. Static electrical characteristics (per diode)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I_ (1)	$I_{R}^{(1)} \begin{array}{c} \text{Reverse leakage} \\ \text{current} \end{array} \begin{array}{c} T_{j} = 25 \ ^{\circ}\text{C} \\ T_{j} = 125 \ ^{\circ}\text{C} \end{array} V_{R} = V_{RRM} \end{array}$			10	μA		
'R` ′		$T_j = 125 \text{ °C}$ $V_R = V_{RRM}$		3	10	mA	
		T _j = 25 °C	I _F = 20 A			0.80	
V _E ⁽¹⁾	Forward voltage drop	T _j = 125 °C	I _F = 20 A		0.62	0.67	V
VF`'		T _j = 25 °C	I _F = 40 A			0.90	v
		T _j = 125 °C	I _F = 40 A		0.70	0.76	

1. Pulse test: $t_p = 380 \ \mu s, \ \delta < 2\%$

To evaluate the conduction losses use the following equation:

 $P = 0.58 \text{ x } I_{F(AV)} + 0.0045 I_{F}^{2}(RMS)$



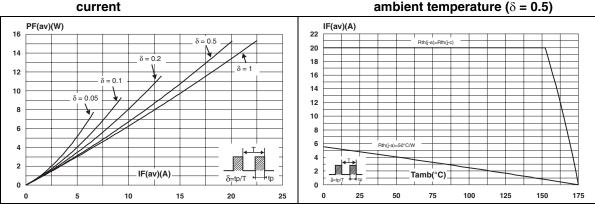
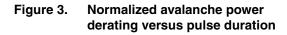
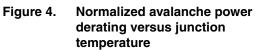
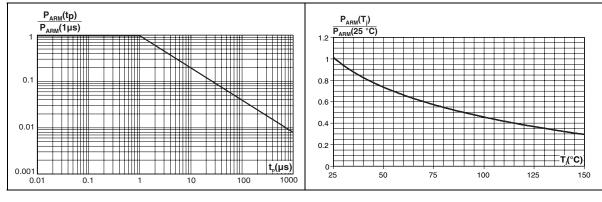
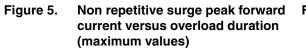


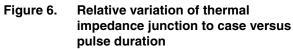
Figure 1. Conduction losses versus average Figure 2. Average forward current versus ambient temperature ($\delta = 0.5$)

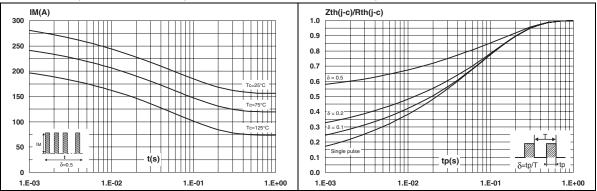






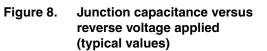


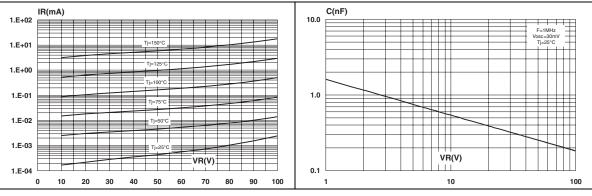


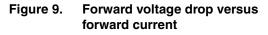


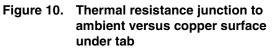
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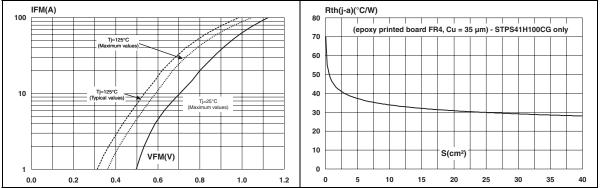
Figure 7. Reverse leakage current versus reverse voltage applied (typical values)













2 Package information

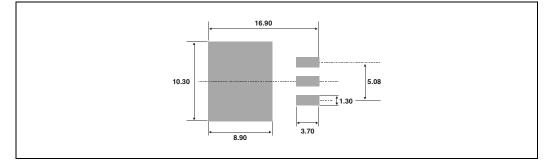
- Epoxy meets UL94, V0
- Cooling method: by conduction (C)

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 Table 5.
 D²PAK dimensions

		Dimensions			
	Ref.	Millimeters		Inches	
		Min.	Max.	Min.	Max.
	А	4.40	4.60	0.173	0.181
	A1	2.49	2.69	0.098	0.106
	A2	0.03	0.23	0.001	0.009
	В	0.70	0.93	0.027	0.037
	B2	1.14	1.70	0.045	0.067
	С	0.45	0.60	0.017	0.024
	C2	1.23	1.36	0.048	0.054
	D	8.95	9.35	0.352	0.368
G	E	10.00	10.40	0.393	0.409
	G	4.88	5.28	0.192	0.208
	L	15.00	15.85	0.590	0.624
M . *	L2	1.27	1.40	0.050	0.055
* FLAT ZONE NO LESS THAN 2mi	L3	1.40	1.75	0.055	0.069
	М	2.40	3.20	0.094	0.126
	R	0.40) typ.	0.01	6 typ.
	V2	0°	8°	0°	8°

Figure 11. Footprint (dimensions in mm)



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3 Ordering information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS41H100CGY-TR	STPS41H100CGY	D ² PAK	1.48 g	1000	Tape and reel

4 Revision history

Table 7.Document revision history

Date	Revision	Changes
21-Oct-2011	1	Initial release.



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